

CKC33C563JDGAC7210

KC-LINK Comm COG, Ceramic, 0.056 uF, 5%, 1000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 3640



Click here for the 3D model.

Dimensions	
Chip Size	3640
L	9.3mm +/-0.6mm
W	10.2mm +/-0.4mm
Т	2.5mm +/-0.20mm
В	1.27mm +/-0.4mm

	Packaging Specifications		
	Packaging	T&R, 330mm, Plastic Tape	
	Packaging Quantity	1000	
	5 5		

General Information		
Series	KC-LINK Comm COG	
Style	SMD Chip	
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I	
Features	Ultra-Stable, Low Loss, Class I	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Component Weight	1.06 g	
Shelf Life	78 Weeks	
MSL	1	

Specifications			
Capacitance	0.056 uF		
Measurement Condition	1 kHz 1.0Vrms		
Capacitance Tolerance	5%		
Voltage DC	1000 VDC		
Dielectric Withstanding Voltage	1200 VDC		
Temperature Range	-55/+150°C		
Temperature Coefficient	COG		
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms		
Dissipation Factor	0.1% 1 kHz 1.0Vrms		
Aging Rate	0% Loss/Decade Hour		
Insulation Resistance	17.8571 GOhms		

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